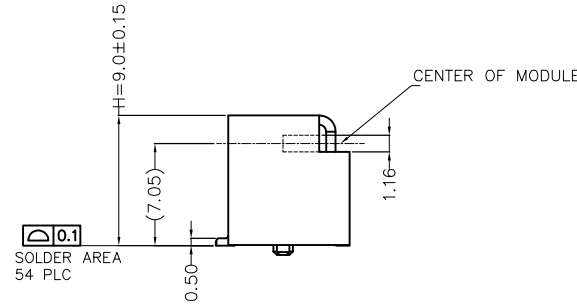
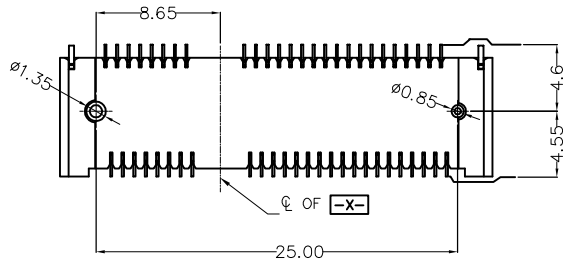
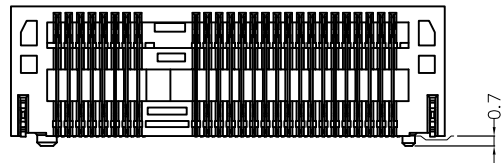
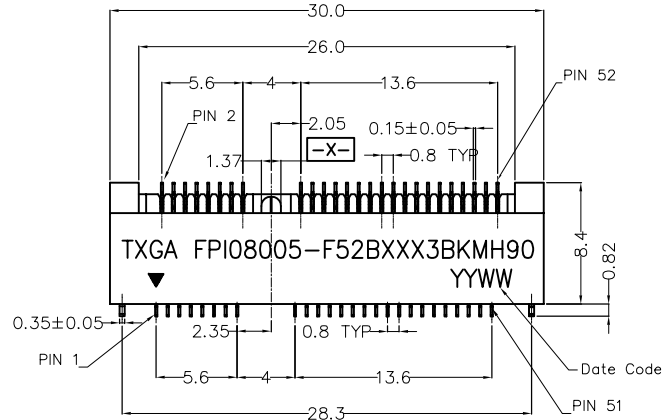




SPECIFICATIONS

Electrical

Current Rating: 0.5A AC(rms)/DC
Voltage Rating: 50V AC(rms)/DC
Contact Resistance: 55mΩ Max
Insulation Resistance: 500MΩ Min
Withstanding Voltage: 300V AC r.m.s
Temperature Range-Operating: -40°C ~ +80°C

Material

Housing: LCP (UL 94V-0) Black
Contact: Copper Alloy/ Selected gold plated on contact area,
1u" Min. gold plated on solder tails
Pegs: Copper Alloy/ 120u" Min. Matte Tin Plated

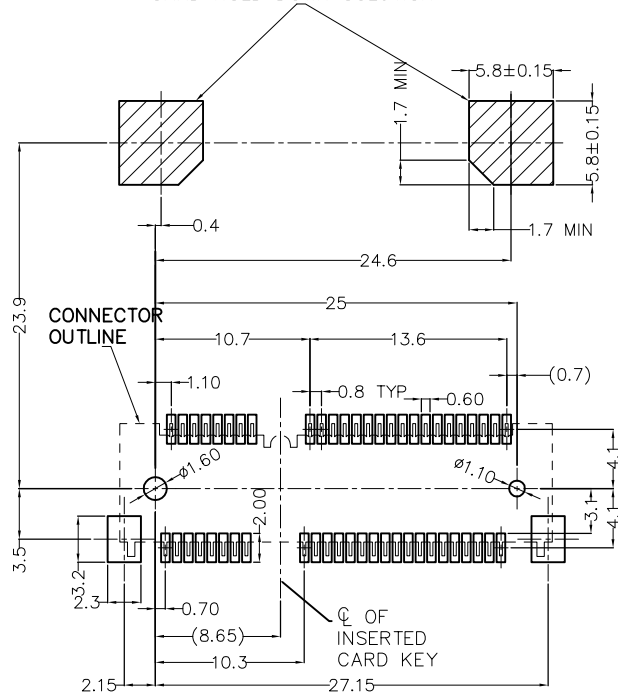
Ordering Information

FPI 080 05 — F 52 B 1 XX 3 BK M H90
1 2 3 4 5 6 7 8 9 10 11 12

1 Category FPI-MINI PCI	2 Series Number 080-Pitch0.80mm	3 Distinction No. 05	4 Type F-Female	5 Circuits 52	6 Entry Angle B-90° Angle	7 Plating 1-Gold Plated
8 thickness of Gold Plating 00-Gold Flash 10-10u" 30-30u"	9 Material-Resin 3-LCP	10 Color-Resin BK-Black	11 Packaging M-Reel	12 Connector Height(H) H90-9.0mm		

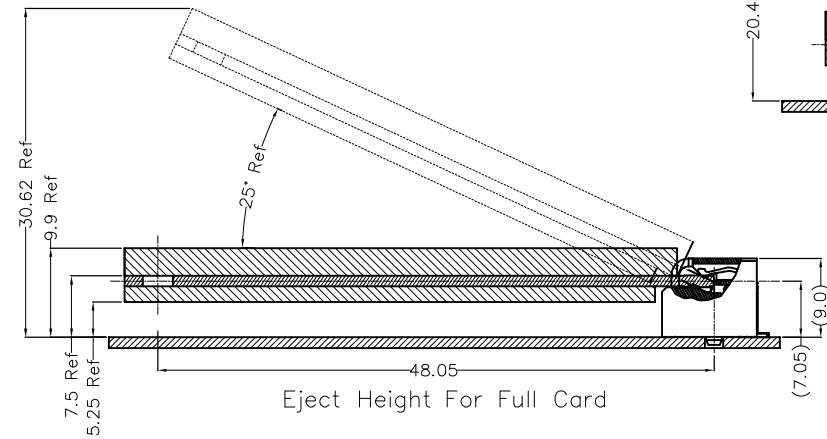
 THIRD ANGLE PROJECTION		GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY LEO	DATE 20/JUL/24	PART NO. FPI08005-F52BXXX3BKMH90	ITEM NO. FPI08005	 Building Technology Cornerstone	
		X. ±0.30	X.* ±5°	CHECKED BY	DATE	TITLE MINI PCI Express (H9.0mm) Pitch 0.8mm 90° Angle			
DESIGN UNITS METRIC(mm)		X.X ±0.20	X.X* ±2°	GISELLE	20/JUL/24			REV 0	
SCALE 5:1	SIZE A4	X.XX ±0.15	X.XX* ±1°	DRAWN BY MATT	DATE 20/JUL/24	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
		X.XXX ±0.10	X.XXX* ±0.5°						

COMPONENT KEEP OUT AREA FOR
CARD HOLD DOWN SOLUTION

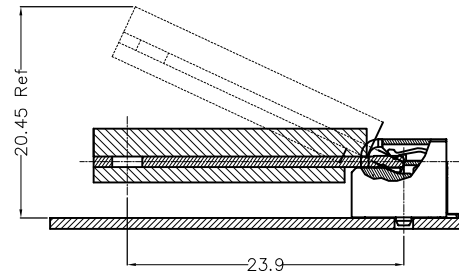


Recommended P.C.Board Layout For Half Card

General tolerances: $\pm 0.05\text{mm}$

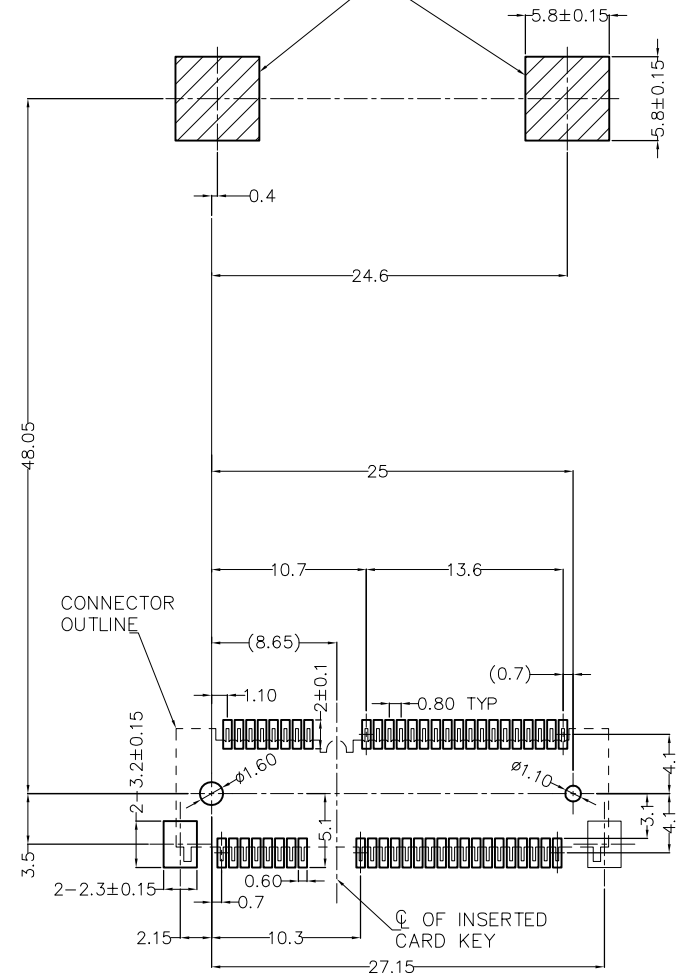


Eject Height For Full Card



Eject Height For Half Card

COMPONENT KEEP OUT AREA FOR
CARD HOLD DOWN SOLUTION



Recommended P.C.Board Layout For Full Card

General tolerances: $\pm 0.05\text{mm}$

 THIRD ANGLE PROJECTION		GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY LEO	DATE 20/JUL/24	PART NO. FPI08005-F52BXXX3BKMH90	ITEM NO. FPI08005	 Building Technology Cornerstone	
		X. ±0.30	X.* ±5°	CHECKED BY GISELLE	DATE 20/JUL/24	TITLE MINI PCI Express (H9.0mm) Pitch 0.8mm 90° Angle			
DESIGN UNITS METRIC(mm)		XX ±0.20	XX.* ±2°		DRAWN BY MATT			DATE 20/JUL/24	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION
SCALE 5:1	SIZE A4	XX.X ±0.15	XX.X.* ±1°						
		XXX ±0.10	XXX.* ±0.5°						
						REV 0		SHEET NO. 2/2	